



### 60V +175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

## **Product Summary**

BV <sub>DSS</sub>	Rds(on) max	I <sub>D MAX</sub> T <sub>C</sub> = +25°C
60V	8mΩ @ V <sub>GS</sub> = 10V	98A
	12mΩ @ V <sub>GS</sub> = 4.5V	80A

### **Features**

- Rated to +175°C—Ideal for High Ambient Temperature
  Environments
- 100% Unclamped Inductive Switching (UIS) Test in Production— Ensures More Reliable and Robust End Application
- Low R<sub>DS(ON)</sub>—Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- Wettable Flank for Improved Optical Inspection
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMTH6010LPSWQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

## **Description and Applications**

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP, and is ideal for use in:

- Engine-management systems
- Body control electronics
- DC-DC converters

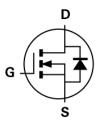
### **Mechanical Data**

- Package: PowerDI<sup>®</sup>5060-8
- Package Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish—Matte Tin Annealed over Copper Leadframe;
   Solderable per MIL-STD-202, Method 208 ©3
- Weight: 0.097 grams (Approximate)

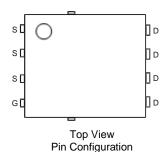


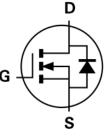
Site 2: PowerDIEGGO 8/SM/D /Type LIV



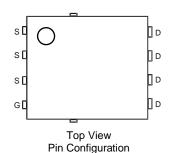


Internal Schematic





Internal Schematic



Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Load free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



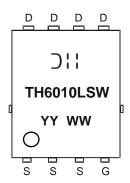
## Ordering Information (Note 4)

Part Number	Package	Packing		
Fait Number	Fackage	Qty.	Carrier	
DMTHEOLOI DCWO 12	PowerDI5060-8 (SWP) (Type Q)	2500	Tape & Reel	
DMTH6010LPSWQ-13	PowerDI5060-8/SWP (Type UX)	2500	Tape & Reel	

Note:

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# **Marking Information**



TH6010LSW = Product Type Marking Code
YYWW or YYWW = Date Code Marking
YY or YY = Last Two Digits of Year (ex: 24 = 2024)
WW = Week Code (01 to 53)

## **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage		VDSS	60	V
Gate-Source Voltage		Vgss	±20	V
Continuous Dunin Compant 1/ 401/ (Note 5)	$T_A = +25$ °C	ID	15.5	A
Continuous Drain Current, V <sub>GS</sub> = 10V (Note 5)	T <sub>A</sub> = +100°C		11	
Continuous Dunin Compant 1/ 401/ (Note C)	T <sub>C</sub> = +25°C	· I <sub>D</sub>	98	А
Continuous Drain Current, V <sub>GS</sub> = 10V (Note 6)	Tc = +100°C		69	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I <sub>DM</sub>	392	Α
Maximum Continuous Body Diode Forward Current (Note 6)	ls	98	Α	
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1	Ism	392	Α	
Avalanche Current, L = 0.1mH		las	20	Α
Avalanche Energy, L = 0.1mH		E <sub>AS</sub>	20	mJ

## **Thermal Characteristics**

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5) T <sub>A</sub> = +25°C		PD	2.9	W
Thermal Resistance, Junction to Ambient (Note 5)		Reja	52	°C/W
Total Power Dissipation (Note 6) $T_C = +25^{\circ}C$		P <sub>D</sub>	115	W
Thermal Resistance, Junction to Case (Note 6)		Rejc	1.3	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +175	°C

Notes: 5. Device mounted on FR-4 substrate PCB, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

6. Thermal resistance from junction to soldering point (on the exposed drain pad).



# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BVDSS	60	_	_	V	$V_{GS} = 0V$ , $I_D = 1mA$
Zero Gate Voltage Drain Current	IDSS	_	_	1	μA	V <sub>DS</sub> = 48V, V <sub>GS</sub> = 0V
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 20V$ , $V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	Vgs(TH)	1	_	3	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$
Static Drain-Source On-Resistance	D- avair		5.3	8	mΩ	$V_{GS} = 10V, I_D = 20A$
Static Dialii-Source Oil-Resistance	R <sub>DS(ON)</sub>		7.9	12	11122	$V_{GS} = 4.5V, I_D = 20A$
Diode Forward Voltage	VsD	_	0.8	1.2	V	V <sub>G</sub> S = 0V, I <sub>S</sub> = 20A
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss	_	2090	_		.,
Output Capacitance	Coss		746	_	pF	$V_{DS} = 30V$ , $V_{GS} = 0V$ f = 1MHz
Reverse Transfer Capacitance	Crss	_	38.5	_		
Gate Resistance	$R_g$	_	0.59	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$
Total Gate Charge (V <sub>GS</sub> = 4.5V)	$Q_g$	_	19.3	_		
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	_	41.3	_	nC	V <sub>DS</sub> = 30V, I <sub>D</sub> = 20A
Gate-Source Charge	Qgs	_	6	_	nc nc	
Gate-Drain Charge	$Q_{gd}$	_	8.8	_		
Turn-On Delay Time	td(on)	_	5.7	_		
Turn-On Rise Time	t <sub>R</sub>	_	4.3	_		$\begin{split} V_{DD} &= 30 \text{V},  V_{GS} = 10 \text{V} \\ I_{D} &= 20 \text{A},  R_{g} = 3 \Omega \end{split}$
Turn-Off Delay Time	tD(OFF)	_	23.4	_	ns	
Turn-Off Fall Time	t <sub>F</sub>	_	9.7	_		
Body Diode Reverse Recovery Time	trr	_	35.4	_	ns	
Body Diode Reverse Recovery Charge	Qrr		38.2	_	nC	IF = 20A, di/dt = 100A/μs

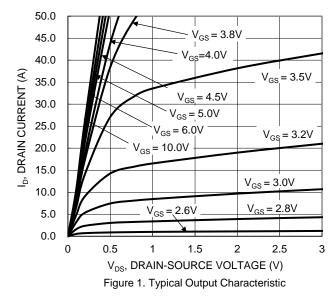
Notes:

<sup>7.</sup> Short duration pulse test used to minimize self-heating effect.

<sup>8.</sup> Guaranteed by design. Not subject to product testing.







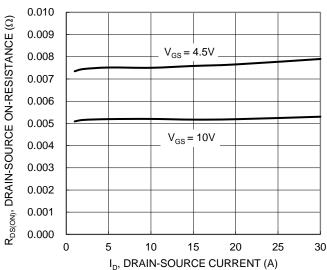


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

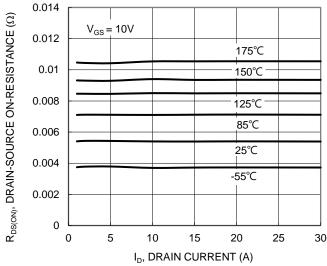


Figure 5. Typical On-Resistance vs. Drain Current and Temperature

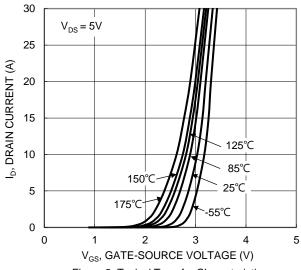


Figure 2. Typical Transfer Characteristic

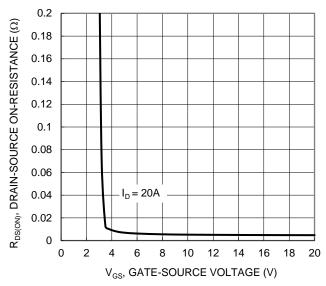


Figure 4. Typical Transfer Characteristic

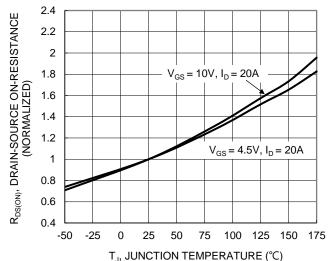


Figure 6. On-Resistance Variation with Temperature





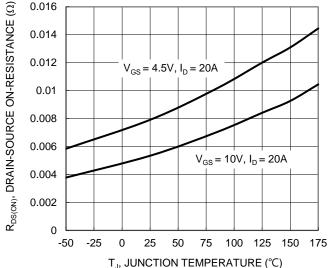


Figure 7. On-Resistance Variation with Temperature

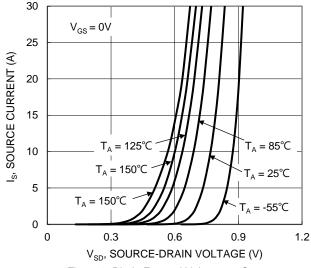
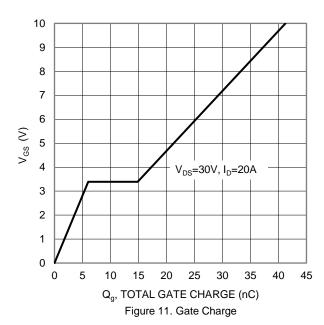


Figure 9. Diode Forward Voltage vs. Current



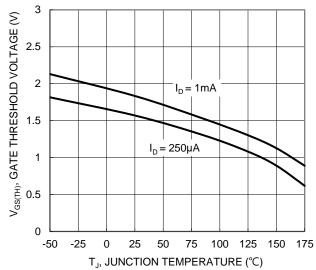


Figure 8. Gate Threshold Variation vs. Junction Temperature

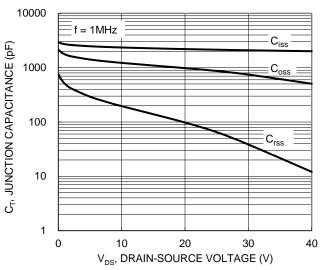
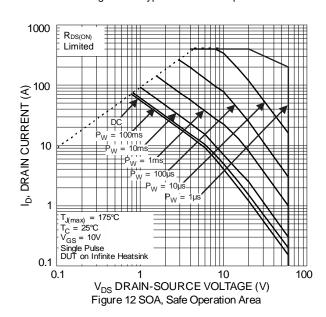


Figure 10. Typical Junction Capacitance





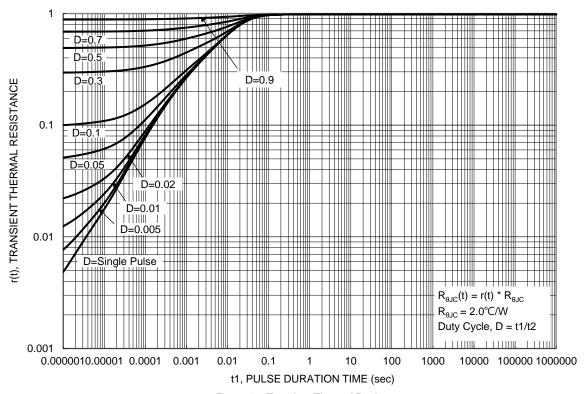


Figure 13. Transient Thermal Resistance

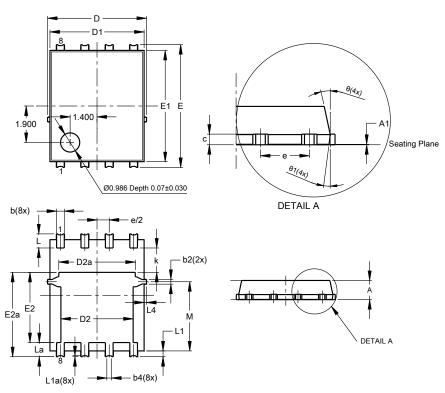


# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### Site 1:

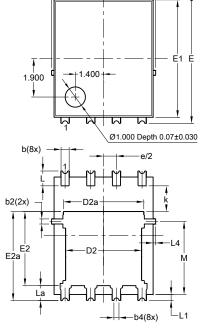
## PowerDI5060-8 (SWP) (Type Q)



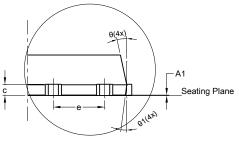
PowerDI5060-8 (SWP) (Type Q)			
Dim	Min	Max	Тур
Α	0.90	1.10	1.00
<b>A</b> 1	0	0.05	
b	0.30	0.50	0.41
b2	0.20	0.35	0.25
b4	C	).25REF	
С	0.230	0.330	0.277
D	5	.15 BS0	
D1	4.70	5.10	4.90
D2	3.56	3.96	3.76
D2a	3.78	4.18	3.98
Е	6	.40 BS0	
E1	5.60	6.00	5.80
E2	3.46	3.86	3.66
E2a	4.195	4.595	4.395
е	1	.27BSC	)
k	1.05		
L	0.635	0.835	0.735
La	0.635	0.835	0.735
L1	0.200	0.400	0.300
L1a	0.050REF		
L4	0.025	0.225	0.125
М	3.205	4.005	3.605
θ	10°	12°	11°
θ1	6°	8°	7°
All Dimensions in mm			

Site 2:

### PowerDI5060-8/SWP (Type UX)



D1



DETAIL A

DETAIL A

PowerDI5060-8/SWP				
(Type UX)				
Dim	Min	Max	Тур	
Α	0.90	1.10	1.00	
<b>A</b> 1	0	0.05		
b	0.30	0.50	0.41	
b2	0.20	0.35	0.25	
b4	(	).25REF	-	
С	0.230	0.330	0.277	
D	5	.15 BS0	2	
D1	4.70	5.10	4.90	
D2	3.56	3.96	3.76	
D2a	3.78	4.18	3.98	
E	6	.40 BS0	2	
E1	5.60	6.00	5.80	
E2	3.46	3.86	3.66	
E2a	4.195	4.595	4.395	
е	1.27BSC			
k	1.05			
L	0.635	0.835	0.735	
La	0.635	0.835	0.735	
L1	0.200	0.400	0.300	
L1a	0.050REF			
L4	0.025	0.225	0.125	
М	3.205	4.005	3.605	
θ	10°	12°	11°	
θ1	6°	8°	7°	
All Dimensions in mm				

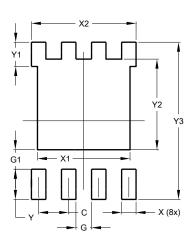


# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

Site 1:

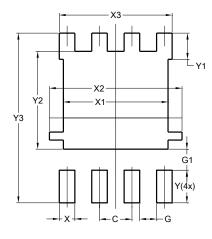
## PowerDI5060-8 (SWP) (Type Q)



Dimensions	Value (in mm)		
	(111 111111)		
С	1.270		
G	0.660		
G1	0.820		
Х	0.610		
X1	4.100		
X2	4.420		
Υ	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		

Site 2:

## PowerDI5060-8/SWP (Type UX)



Dimensions	Value
Dilliensions	(in mm)
С	1.270
G	0.660
G1	0.820
X	0.610
X1	4.100
X2	5.190
Х3	4.420
Υ	1.270
Y1	1.020
Y2	3.810
Y3	6.610



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